## TR IEC/TR 62541-1:2022 IEC/TR 62541-1:2020, IDT

(ICS 25.040.40; 35.100.01)

## **TECHNICAL REFERENCE**

# **OPC** unified architecture

– Part 1 : Overview and concepts





### TR IEC/TR 62541-1:2022

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### **OPC** unified architecture

- Part 1: Overview and concepts

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#### TR IEC/TR 62541-1:2022

#### **National Foreword**

This Technical Reference (TR) was prepared by the Working Group on OPC unified architecture set up by the Technical Committee on Smart Manufacturing under the purview of the Manufacturing Standards Committee.

This TR is a revision of TR IEC/TR 62541-1:2019 and is an identical adoption of IEC/TR 62541-1:2020, "OPC unified architecture – Part 1: Overview and concepts", published by the International Electrotechnical Commission.

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# IEC TR 62541-1

Edition 3.0 2020-11

# TECHNICAL REPORT



OPC unified architecture – Part 1: Overview and concepts





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67 000 electrotechnical terminology entries in English and French extracted from the Terms and Definitions clause of IEC publications issued since 2002. Some entries have been collected from earlier publications of IEC TC 37, 77, 86 and CISPR.



## IEC TR 62541-1

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# TECHNICAL REPORT



OPC unified architecture – Part 1: Overview and concepts

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#### INTERNATIONAL ELECTROTECHNICAL COMMISSION

#### **OPC UNIFIED ARCHITECTURE -**

#### Part 1: Overview and concepts

#### **FOREWORD**

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IEC TR 62541-1, which is a Technical Report, has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

This third edition cancels and replaces the second edition of IEC TR 62541-1, published in 2016. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) added Subclauses 6.5 and 6.6 and other text throughout to include PubSub introduction;
- b) added new transports and encodings to existing overview sections;
- c) removed WS-SecureConversation example since this mapping has been deprecated;

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d) improved the definition of Certificate.

The text of this Technical Report is based on the following documents:

Enquiry draft	Report on voting
65E/678/DTR	65E/702/RVDTR

Full information on the voting for the approval of this technical report can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

Throughout this document and the referenced other Parts of the series, certain document conventions are used:

*Italics* are used to denote a defined term or definition that appears in the "Terms and definition" clause in one of the parts of the series.

*Italics* are also used to denote the name of a service input or output parameter or the name of a structure or element of a structure that are usually defined in tables.

The *italicized terms* and names are also often written in camel-case (the practice of writing compound words or phrases in which the elements are joined without spaces, with each element's initial letter capitalized within the compound). For example, the defined term is *AddressSpace* instead of Address Space. This makes it easier to understand that there is a single definition for AddressSpace, not separate definitions for Address and Space.

A list of all parts of the IEC 62541 series, published under the general title OPC Unified Architecture, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

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#### **OPC UNIFIED ARCHITECTURE -**

#### Part 1: Overview and concepts

#### 1 Scope

This part of IEC 62541 presents the concepts and overview of the OPC Unified Architecture (OPC UA). Reading this document is helpful to understand the remaining parts of this multi-part document set. Each of the other parts of IEC 62451 is briefly explained along with a suggested reading order.

#### 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC TR 62541-2, OPC unified architecture - Part 2: Security Model

IEC 62541-3, OPC unified architecture - Part 3: Address Space Model

IEC 62541-4, OPC unified architecture - Part 4: Services

IEC 62541-5, OPC unified architecture - Part 5: Information Model

IEC 62541-6, OPC unified architecture - Part 6: Mappings

IEC 62541-7, OPC unified architecture - Part 7: Profiles

IEC 62541-8, OPC unified architecture – Part 8: Data access

IEC 62541-9, OPC unified architecture - Part 9: Alarms and Conditions

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IEC 62541-12, OPC unified architecture – Part 12: Discovery and global services

IEC 62541-13, OPC Unified Architecture - Part 13: Aggregates

IEC 62541-14, OPC unified architecture - Part 14: PubSub

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